## TB62752AFUG

## Step Up Type DC/DC Converter for White LED

## Features

The TB62752AFUG is a high efficient Step-Up Type DC/DC Converter specially designed for constant current driving of White LED.
This IC can drive 2-8 white LEDs connected series using a Li-ion battery.
This IC contains N-ch MOS-FET Transistor for Coil-Switching, and LED Current ( $\mathrm{I}_{\mathrm{F}}$ ) is set with an external resistor.
This IC is especially for driving back light white LEDs in LCD of PDA, Cellular Phone, or Handy Terminal Equipment.

## Characteristics



Weight: 0.016 g (Typ.)

- 2-8 white LEDs connected series (Typ. 7LEDs)
- Variable LED Current $I_{F}$ is set with a external resistor :

20 mA (Typ.) @RSENS = $15 \Omega$

- Output Power : Available for 800 mW LED loading
- High Efficiency : 80\% over (Using recommended external parts: Typ. 7LEDs)
- Output Over Voltage Shutdown Function :

Switching Operation is shut downed when OVD terminal Voltage is over 37 V (typ.).

- IC Package : SSOP6=p=0.95B
- Switching Frequency : 1.1 MHz (Typ.)


## Pin Assignment (Top view)



Caution 1: This IC could be destroyed in some case if amounted in $180^{\circ}$ inverse direction.
Please be careful about IC direction in mounting.

## Block Diagram



## Pin Function

| Pin No. | Symbol | Function Description |
| :---: | :---: | :--- |
| 1 | $\overline{\text { SHDN }}$ | Voltage-Input Terminal for IC-Enable / Disable LED-IF. <br> IF adjustment with PWM input signal is also available. |
| 2 | OVD | Over Voltage Detection Terminal. <br> IC Switching Operation is disabled with detection over voltage. <br> If the voltage returns to detection level or less, Operation is enabled again. |
| 3 | VIN | Supply Voltage Input Terminal. ( 2.8V to 5.5V) |
| 4 | SW | Switch Terminal for DC/DC Converter. Nch MOSFET Built-In. |
| 5 | GND | Ground Terminal. |
| 6 | FB | LED IF Setting Resister Connecting Terminal. |

## Absolute Maximum Ratings (Topr $=25^{\circ} \mathrm{C}$ if without notice)

| Characteristics | Symbol | Ratings | Unit |
| :---: | :---: | :---: | :---: |
| Power Supply Voltage | VIN | -0.3 to +6.0 | V |
| Input Voltage | VSHDN | -0.3 to +VIN +0.3 | V |
| Switching Terminal Voltage | Vo (SW) | -0.3 to 40 | V |
| Switching Terminal Current | Io (SW) | 1500 | mA |
| Power Dissipation | PD | 0.41 (Device) | W |
|  |  | 0.47 (on PCB) Caution 2 |  |
| Thermal Resistance | Rth (j-a) | 300 (Device) | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | 260 (on PCB) |  |
| Operation Temperature Range | Topr | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | Tstg | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature | Tj | 150 | ${ }^{\circ} \mathrm{C}$ |

Caution 2: $\quad$ Power Dissipation must be calculated with subtraction of $3.8 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ from Maximum Rating with every $1^{\circ} \mathrm{C}$ if $\mathrm{T}_{\text {opr }}$ is upper $25^{\circ} \mathrm{C}$. (on PCB)

## Recommended Operating Condition ( $\mathrm{Ta}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ if without notice)

| Characteristics | Symbol | Test <br> Circuit | Test Condition | Min | Typ | Max | Unit |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Voltage | VIN | - |  | 2.8 | - | 5.5 | V |
| LED Current (Average Value) | Io1 | - | VIN $=3.6$ V, RSENS $=15 \Omega$ <br> 4LEDs, Topr $=25^{\circ} \mathrm{C}$ | - | 20 | - | mA |

Electrical Characteristics ( $\mathrm{Ta}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{IN}}=2.8 \mathrm{~V}$ to 5.5 V if without notice)

| Characteristics | Symbol | Test Condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Voltage Range | $\mathrm{V}_{\text {IN }}$ |  | 2.8 | - | 5.5 | V |
| Operating Consumption Current | $\mathrm{lin}(\mathrm{On})$ | $\mathrm{VIN}=3.6 \mathrm{~V}, \mathrm{RSENS}=15 \Omega$ | - | TBD | - | mA |
| Quiescent Consumption Current | $\mathrm{I}_{\text {IN }}(\mathrm{Off})$ | $\mathrm{VIN}=3.6 \mathrm{~V}, \mathrm{~V} \overline{\text { SHDN }}=0 \mathrm{~V}$ | - | 0.5 | 1.0 | $\mu \mathrm{A}$ |
| SHDN Terminal 'H' Level Input Voltage | VSHDNH | - | 1.3 | - | VIN | V |
| SHDN Terminal 'L' Level Input Voltage | V $\overline{S H D N L}$ | - | 0 | - | 0.4 | V |
| $\overline{\text { SHDN }}$ Terminal Current | ISHDN | $\mathrm{VIN}=3.6 \mathrm{~V}, \mathrm{~V}_{\text {SHDN }}=3.6 \mathrm{~V}$ | - | 0 | 1.0 | $\mu \mathrm{A}$ |
| Integrated MOS-Tr Switching Frequency | fosc | $\mathrm{VIN}=3.6 \mathrm{~V}, \widehat{\widehat{S H D N}} \overline{ }=3.6 \mathrm{~V}$ | 0.77 | 1.1 | 1.43 | MHz |
| Switching Terminal Current | loz (SW) | - | - | 600 | - | mA |
| Switching Terminal Leak Current | loz (SW) | - | - | 0.5 | 1 | $\mu \mathrm{A}$ |
| FB Terminal Feedback Voltage $\left(V_{F B}\right)$ | $V_{\text {FB }}$ | $\begin{gathered} \mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}, \mathrm{RSENS}=15 \Omega \\ \mathrm{~T}_{\text {opr }}=25^{\circ} \mathrm{C}, \mathrm{~L}=22 \mu \mathrm{H} \end{gathered}$ | 285 | 300 | 315 | mV |
| FB Terminal Line Regulation | $\Delta \mathrm{V}_{\text {FB }}$ | $\begin{aligned} & \mathrm{V}_{\text {IN }}=3.6 \mathrm{~V} \text { center } \\ & \mathrm{V}_{\mathrm{IN}}=3.0 \text { to } 5.0 \mathrm{~V} \end{aligned}$ | -5 | - | 5 | \% |
| FB Terminal Current | Ioz (SW) | - | - | TBD | - | $\mu \mathrm{A}$ |
| OVD terminal Voltage | Vovd | - | 34.5 | 37 | 39.5 | V |
| OVD Terminal Leakage Current | lovdz | $\mathrm{V}_{\text {ovd }}=30 \mathrm{~V}$ | - | 0.5 | 1 | $\mu \mathrm{A}$ |

## Protection in LED opened condition

The operation with OVD terminal is available for the protection in case LED Circuit opened.
Please see the example of application circuit.
If load of LED is detached, Nch MOS switching operation is disabled with detection of boost circuit voltage.

## Setting of external Capacitor

In case not using PWM signal to SHDN terminal for brightness control, recommended values are $\mathrm{C}_{1}=$ Over $2.2(\mu \mathrm{~F}), \mathrm{C}_{2}=$ Over $1.0(\mu \mathrm{~F})$

In case with PWM signal to SHDN terminal for brightness control, recommended values are $\mathrm{C}_{1}=$ Over $4.7(\mu \mathrm{~F}), \mathrm{C}_{2}=$ Under $0.1(\mu \mathrm{~F})$ to reduce fluctuation of input current and up accuracy of brightness.

The recommended capacitor values depend on the Brightness Control Method.
<Please see after page-8>
The capacitor value must be considered for gain enough accuracy of brightness with reduction of noise from Input current changing.

## Setting of lo

Resistance connects between RSENS pin and GND.
The average current is set by this RSENS value and average current are obtained by the following equation.

$$
\mathrm{I}_{F}[\mathrm{~mA}]=\frac{300[\mathrm{mV}]}{\operatorname{RSENS}[\Omega]}
$$

Current Value error is within $\pm 5 \%$.


Weight : 0.016 g (Typcal)

About solderability, following conditions were confirmed

- Solderability
(1) Use of $\mathrm{Sn}-63 \mathrm{~Pb}$ solder Bath
- solder bath temperature $=230^{\circ} \mathrm{C}$
- dipping time $=5$ seconds
- the number of times = once
- use of R-type flux
(2) Use of $\mathrm{Sn}-3.0 \mathrm{Ag}-0.5 \mathrm{Cu}$ solder Bath
- solder bath temperature $=245^{\circ} \mathrm{C}$
- dipping time $=5$ seconds
- the number of times = once
- use of R-type flux


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